N-Channel 100-V (D-S) MOSFET

Key Features:

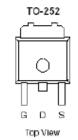
- Low r_{DS(on)} trench technology
- · Low thermal impedance
- · Fast switching speed

Typical Applications:

- PoE Power Sourcing Equipment
- PoE Powered Devices
- Telecom DC/DC converters
- · White LED boost converters

PRODUCT SUMMARY			
V _{DS} (V)	$r_{DS(on)}(m\Omega)$	I _D (A)	
100	78 @ V _{GS} = 10V	21	
	92 @ V _{GS} = 4.5V	19	





ABSOLUTE MAXIMUM RATINGS (T _A = 25°C UNLESS OTHERWISE NOTED)					
Parameter		Symbol	Limit	Units	
Drain-Source Voltage			100	V	
Gate-Source Voltage			±20	V	
Continuous Drain Current	T _C =25°C	I _D	21	Α	
Pulsed Drain Current b			100	^	
Continuous Source Current (Diode Conduction)	l _s	30	Α		
Power Dissipation	T _C =25°C	P_{D}	50	W	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Maximum	Units		
Maximum Junction-to-Ambient ^a	$R_{\theta JA}$	50	°C/W		
Maximum Junction-to-Case	$R_{\theta JC}$	3	C/VV		

Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

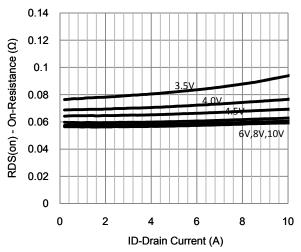
Parameter	Symbol Test Conditions		Min	Тур	Max	Unit	
Static							
Gate-Source Threshold Voltage	$V_{GS(th)}$ $V_{DS} = V_{GS}$, ID = 250 uA					V	
Gate-Body Leakage	I _{GSS}	1			±10	uA	
Zara Cata Valtara Drain Current	1	$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}$			1	uA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			25		
On-State Drain Current	$I_{D(on)}$	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	34			Α	
Drain-Source On-Resistance	r	$V_{GS} = 10 \text{ V}, I_D = 9.2 \text{ A}$			78	mΩ	
Dialii-Source Off-Resistance	r _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 6.1 \text{ A}$			92	11122	
Forward Transconductance	g_{fs}	$V_{DS} = 40 \text{ V}, I_{D} = 5.5 \text{ A}$		20		S	
Diode Forward Voltage	V_{SD}	I _S = 9 A, V _{GS} = 0 V		0.8		V	
		Dynamic					
Total Gate Charge	Q_g			21			
Gate-Source Charge	Q_gs	$V_{DS} = 50 \text{ V}, V_{GS} = 4.5 \text{ V}, ID = 9 \text{ A}$		3.8		nC	
Gate-Drain Charge	Q_{gd}			14.2			
Turn-On Delay Time	t _{d(on)}			7.5			
Rise Time	t _r	V_{DD} = 50 V, R_L = 5.2 Ω , I_D = 9.6 A,		13.6		nC	
Turn-Off Delay Time	$t_{d(off)}$	V_{GEN} = 10 V, R_{GEN} = 6 Ω		41		nS	
Fall-Time	t _f			35			

Notes

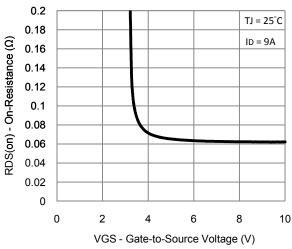
- a. Pulse test: PW <= 300us duty cycle <= 2%.
- b. Guaranteed by design, not subject to production testing.

Analog Power (APL) reserves the right to make changes without further notice to any products herein. APL makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does APL assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in APL data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. APL does not convey any license under its patent rights nor the rights of others. APL products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the APL product could create a situation where personal injury or death may occur. Should Buyer purchase or use APL products for any such unintended or unauthorized application, Buyer shall indemnify and hold APL and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that APL was negligent regarding the design or manufacture of the part. APL is an Equal Opportunity/Affirmative Action Employer.

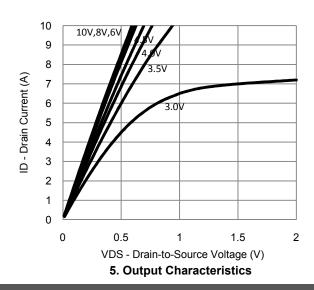
Typical Electrical Characteristics

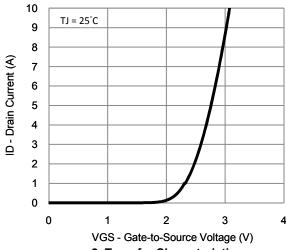


1. On-Resistance vs. Drain Current

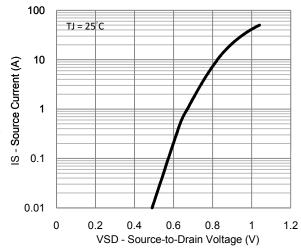


3. On-Resistance vs. Gate-to-Source Voltage

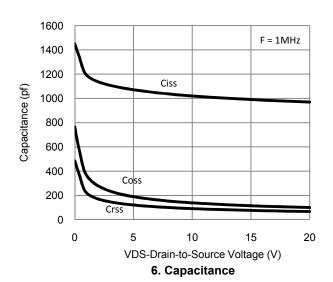




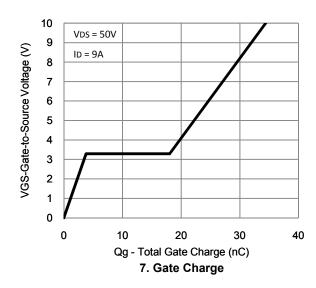
2. Transfer Characteristics

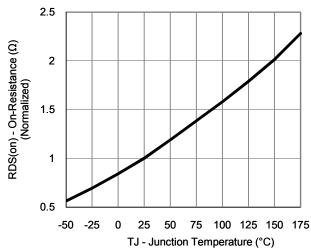


4. Drain-to-Source Forward Voltage

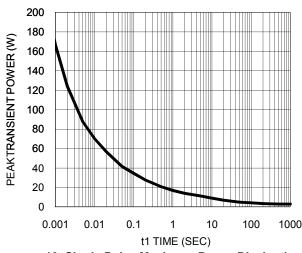


Typical Electrical Characteristics





8. Normalized On-Resistance Vs
Junction Temperature



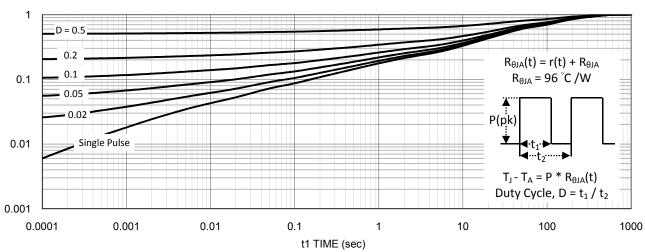
VDS Drain to Source Voltage (V)

9. Safe Operating Area

10

100

10. Single Pulse Maximum Power Dissipation

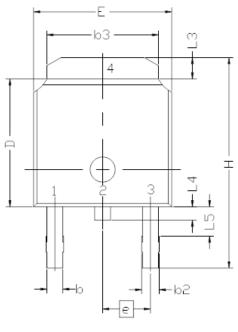


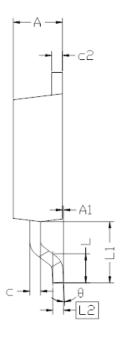
1000

11. Normalized Thermal Transient Junction to Ambient

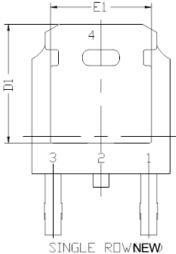
0.1

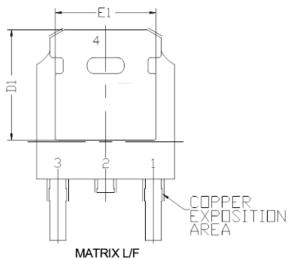
Package Information





CVMDEI	DIMENS:	[DNAL	REQMTS
SYMBOL	MIN	NDM	MAX
E	6.40	6.60	6.731
L	1.40	1.52	1.77
L1	2	.743 R	ĒF
	0.	.508 BS	
_L3	0.89		1.27
L4	0.64		1.01
L5			
D	6.00	6.10	6,223
Н	9.40	10.00	10.40
b	0.64	0.76	0,88
b2	0.77	0.84	1.14
b3	5,21	5.34	5.46
е	2.	286 BS	SC.
Α	2,20	2,30	2,38
A1	0		0.127
	0.45	0.50	0,60
c2	0.45	0,50	0.58
D1	5,30		
E1	4.40		
θ	0°		10°





Note:

- 1. All Dimension Are In mm.
- 2. Package Body Sizes Exclude Mold Flash, Protrusion Or Gate Burrs. Mold Flash, Protrusion Or Gate Burrs Shall Not Exceed 0.10 mm Per Side.
- 3. Package Body Sizes Determined At The Outermost Extremes Of The Plastic Body Exclusive Of Mold Flash, Gate Burrs And Interlead Flash, But Including Any Mismatch Between The Top And Bottom Of The Plastic Body.
- 4. The Package Top May Be Smaller Than The Package Bottom.
- Dimension "b" Does Not Include Dambar Protrusion. Allowable Dambar Protrusion Shall Be 0.10 mm Total In Excess
 Of "b" Dimension At Maximum Material Condition. The Dambar Cannot Be Located On The Lower Radius Of The
 Foot.